
**Thermoplastics pipes, fittings and
assemblies for the conveyance of
fluids — Determination of the resistance
to internal pressure —**

**Part 3:
Preparation of components**

*Tubes, raccords et assemblages en matières thermoplastiques pour le
transport des fluides — Détermination de la résistance à la pression
interne —*

Partie 3: Préparation des composants



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Foreword

ISO (the International Organization for Standardization) is a worldwide federation of national standards bodies (ISO member bodies). The work of preparing International Standards is normally carried out through ISO technical committees. Each member body interested in a subject for which a technical committee has been established has the right to be represented on that committee. International organizations, governmental and non-governmental, in liaison with ISO, also take part in the work. ISO collaborates closely with the International Electrotechnical Commission (IEC) on all matters of electrotechnical standardization.

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ISO 1167-3 was prepared by Technical Committee ISO/TC 138, *Plastics pipes, fittings and valves for the transport of fluids*, Subcommittee SC 5, *General properties of pipes, fittings and valves of plastic materials and their accessories — Test methods and basic specifications*.

This first edition of ISO 1167-3, together with ISO 1167-2, cancels and replaces ISO 12092:2000, of which it constitutes a technical revision.

ISO 1167-3 consists of the following parts, under the general title *Thermoplastics pipes, fittings and assemblies for the conveyance of fluids — Determination of the resistance to internal pressure*:

- *Part 1: General method*
- *Part 2: Preparation of pipe test pieces*
- *Part 3: Preparation of components*
- *Part 4: Preparation of assemblies*